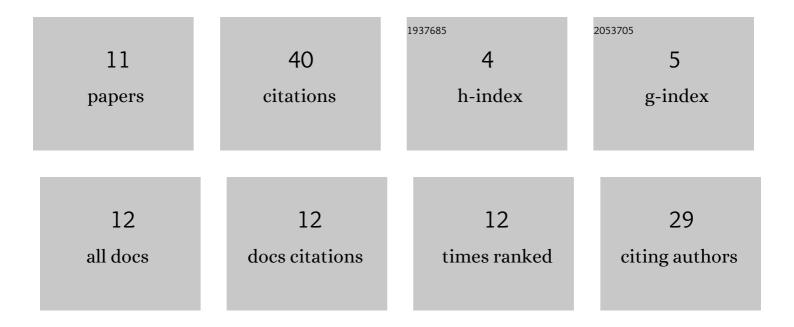
Mariusz Felczak

List of Publications by Year in descending order

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#	Article	IF	CITATIONS
1	Optimal placement of electronic devices in forced convective cooling conditions. Microelectronics Reliability, 2009, 49, 1537-1545.	1.7	12
2	Evaluation of the Heat Transfer Coefficient in Microcircuits From the Frequency Analysis of the Thermal Transient Response. IEEE Transactions on Components and Packaging Technologies, 2010, 33, 260-266.	1.3	8
3	Application of genetic algorithms for electronic devices placement in structures with heat conduction through the substrate. Microelectronics Reliability, 2011, 51, 453-459.	1.7	7
4	Modelling and IR measurement of the electronic substrate thermal conductivity. Microelectronics Reliability, 2015, 55, 138-142.	1.7	5
5	Exact solution for optimal placement of electronic components on linear array using analytical thermal wake function. Electronics Letters, 2008, 44, 1216.	1.0	3
6	Determination of the heat transfer coefficient distribution. , 0, , .		2
7	Thermal management in high-power electronics cooled down using capillary pump. , 2003, , .		0
8	Optimal Placement of Eletronic Devices in Forced Convective Cooling Conditions. , 2007, , .		0
9	Application of genetic algorithms for electronic devices placement. Quantitative InfraRed Thermography Journal, 2008, 5, 195-209.	4.2	0
10	The use of fractional calculus for the optimal placement of electronic components on a linear array. Facta Universitatis - Series Electronics and Energetics, 2015, 28, 77-84.	0.9	0
11	Radiation Model of a Housing of Cooled Infrared Detector Array. , 2021, 25, 67-76.	0.1	0